

SPECIFICATION FOR LCD Module KD024B-3C

MODULE:	KD024B-3C
CUSTOMER:	

REV	DESCRIPTION	DATE
1.0	FIRST ISSUE	2014.09.02

STARTEK	INITIAL	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		

CUSTOMER	INITIAL	DATE
APPROVED BY		

Part. No	KD024B-3C	REV	V1.0	Page 1 of 29



Revision History

Data	Rev. No.	Page	Summary
2014.09.02	V1.0	ALL	FIRST ISSUE

	Part. No	KD024B-3C	REV	V1.0	Page 2 of 29
--	----------	-----------	-----	------	--------------



Contents

General Description	4
1. Block Diagram	5
2. Outline dimension	6
3. Input Terminal Pin Assignment	7
4. LCD Optical Characteristics	9
5. Electrical Characteristics	11
6. AC Characteristic	13
7. LCD Module Out-Going Quality Level	14
8 Reliability Test Result	27
9. Cautions and Handling Precautions	28
10.Packing	29

	Part. No	KD024B-3C	REV	V1.0	Page 3 of 29
--	----------	-----------	-----	------	--------------



General Description

* Description

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This model is composed of a Transmissive type TFT-LCD Panel, driver circuit, backlight unit. The resolution of a 2.4'TFT-LCD contains 240x320 pixels, and can display up to 65K colors.

* Features

-Low Input Voltage: 3.3V(TYP)

-Display Colors of TFT LCD: 65K colors

-Interface:16 BIT MCU interface

General Information	Specification	Unit	Note	
Items	Main Panel	- Unit	Note	
Display area(AA)	36.72(H)*48.96(V) (2.4inch)	mm	-	
Driver element	TFT active matrix	-	-	
Display colors	65K	colors	-	
Number of pixels	240(RGB)*320	dots	-	
Pixel arrangement	RGB vertical stripe	-	-	
Pixel pitch	0.153(H)*0.153(V)	mm	-	
Viewing angle	ALL	o'clock	-	
Controller IC	ILI9341V	-	-	
Display mode	Transmissive/ Normally Black	-	-	
Operating temperature	-20~+70	$^{\circ}$ C	-	
Storage temperature	-30~+80	$^{\circ}$ C	-	

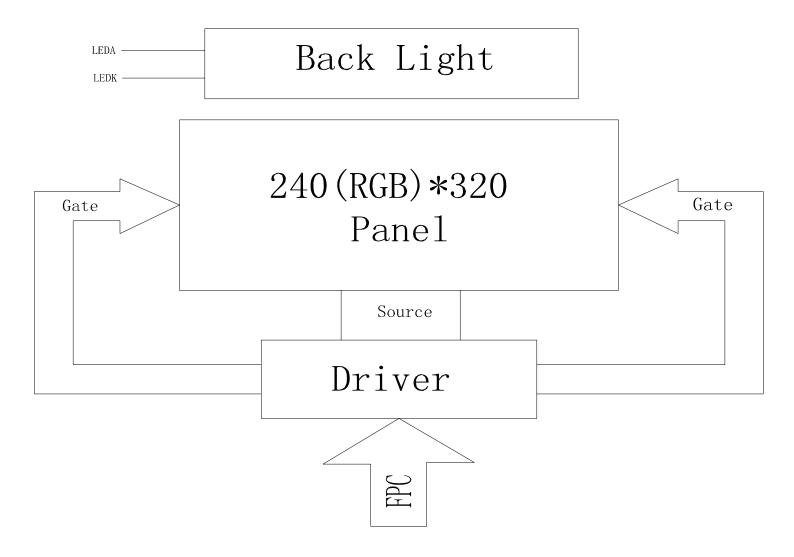
* Mechanical Information

	Item	Min.	Typ.	Max.	Unit	Note
Modulo	Horizontal(H)		42.72		mm	-
Module size	Vertical(V)		60.26		mm	-
	Depth(D)		2.1		mm	-
	Weight		TBD		g	-

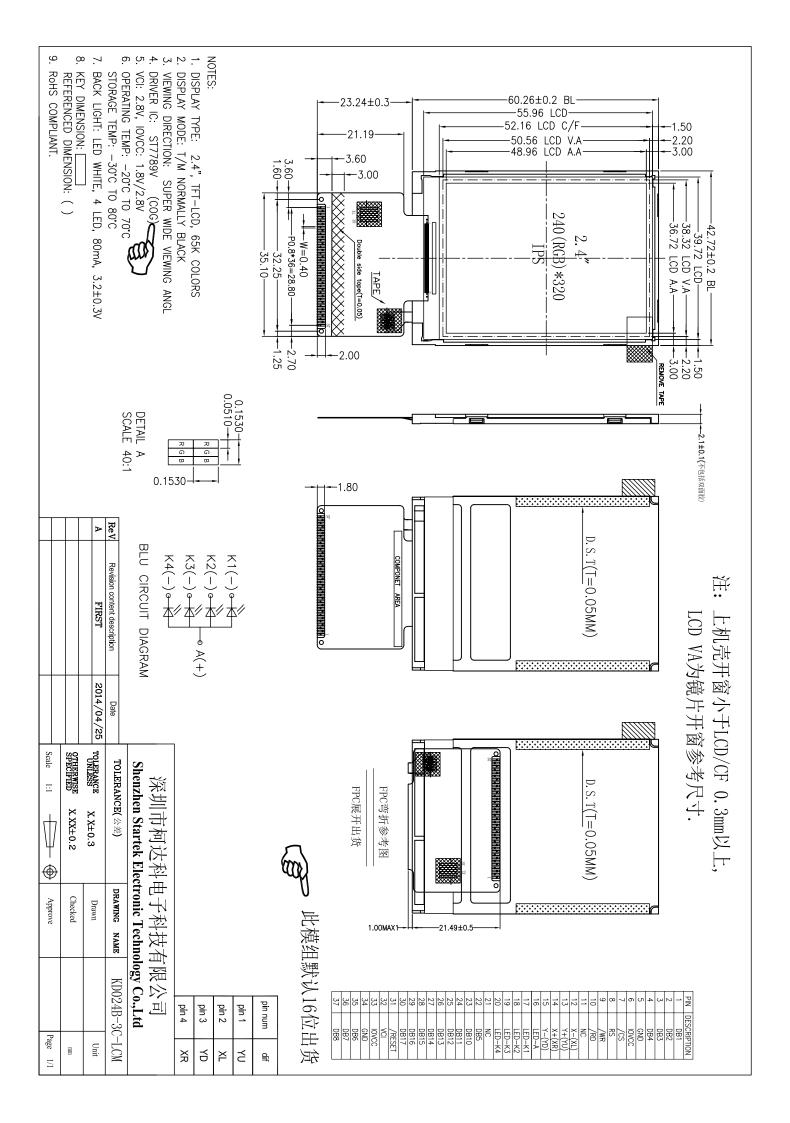
Part. No	KD024B-3C	REV	V1.0	Page 4 of 29
----------	-----------	-----	------	--------------



1. Block Diagram



Part. No	KD024B-3C	REV	V1.0	Page 5 of 29





3. Input terminal Pin Assignment

NO.	SYMBOL	DISCRIPTION	I/O
1-4	DB1-DB4	Data bus.	I/O
5	GND	Ground.	P
6	IOVCC	Supply voltage for IO (1.8V-3.3V).	P
7	/CS	Chip select input pin ("Low" enable). Fix this pin at VCI or GND when not in use.	I
8	RS	Display data / Command selection . D/CX='1': Display data. D/CX='0': Command data.	Ι
9	/WR	Write enable in parallel interface.	I
10	/RD	Serves as a read signal and MCU read data at the rising edge. Fix this pin at VCI or GND when not in use.	Ι
11	NC	NC	
12	X-(XL)	Touch panel LEFT Glass Terminal.	I
13	Y+(YU)	Touch panel Top Film Terminal.	I
14	X+(XR)	Touch panel Right Glass Terminal.	I
15	Y-(YD)	Touch panel Bottom Film Terminal.	I/O
16	LEDA	Anode pin of backlight.	P
17	LED-K1	Cathode pin of backlight.	P
18	LED-K2	Cathode pin of backlight.	P
19	LED-K3	Cathode pin of backlight.	P
20	LED-K4	Cathode pin of backlight.	P
21	NC	NC	
22	DB5	Data bus.	I/O
23	DB10-DB17	Data bus.	I/O
31	RESET	Setting either pin low initializes the LSI. Must be reset after power is supplied.	I
32	VCI	Supply voltage(3.3V).	P
33	IOVCC	Supply voltage for IO (1.8V-3.3V).	p
34	GND	Ground.	p
35-37	DB6-DB8	Data bus.	I/O
Part. No	KD024B	-3C REV V1.0 Page	7 of 29

	Part. No	KD024B-3C	REV	V1.0	Page 7 of 29
--	----------	-----------	-----	------	--------------



4. LCD Optical Characteristics

4.1 Optical specification

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Transmittance (with Polarizer)		T (%)		-	4.65	l	%	Measuring with Polarizer , Reference Only
Transmittance (without Polari	zer)	T (%)		_	14.6	_	%	
Contrast		CR		640	800	_	_	(1)(2)
Response	Rising	T _R		_	16	21		(4)(2)
time	Falling	T _F	Θ=0	_	19	24	msec	(1)(3)
Color gamut	(%)		Normal viewing	_	70	_	%	C-light
	White	W _x	angle	0.290	0.310	0.330		
		W_y		0.316	0.336	0.356		
	Red	R _x		0.627	0.647	0.667		
Color chromaticity		R _Y		0.297	0.317	0.337	_	(1)(4)
(CIE1931)	Green	G _x		0.255	0.275	0.295	_	CF glass
(0.2.00.)		G _Y		0.562	0.582	0.602		
	Blue	B _x		0.120	0.140	0.160	_	
	Diue	B _Y		0.068	0.088	0.108		
		ΘL		_	80	_		(4)(4)
View de er en ele	Hor.	ΘR	OD: 40	_	80	_	_	(1)(4) Measuring with
Viewing angle	Ver.	Θυ	CR>10	_	80	_		Polarizer ,
	ver.	ΘD		_	80	_		Reference Only
Optima View D	irection			Free	е			(5)

4.2 Measuring Condition

■ Measuring surrounding: dark room

■ Ambient temperature: 25±2oC

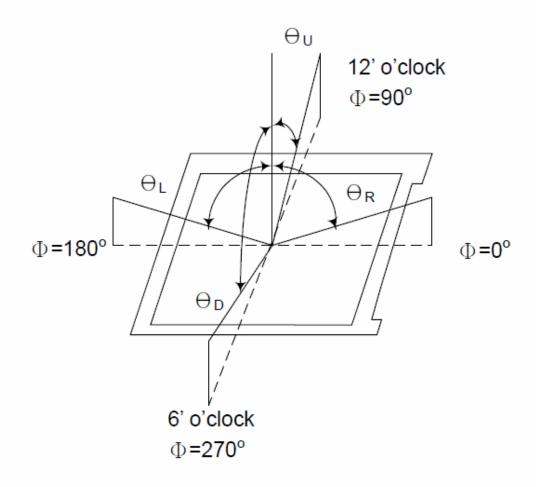
■ 15min. warm-up time

Part. No	KD024B-3C	REV	V1.0	Page 8 of 29

4.3 Measuring Equipment

FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

Note (1) Definition of Viewing Angle:



Note (2) Definition of Contrast Ratio (CR): measured at the center point of panel

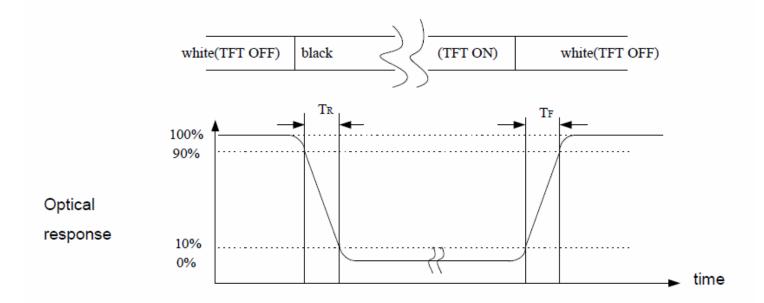
CR = Luminance with all pixels white

Luminance with all pixels black

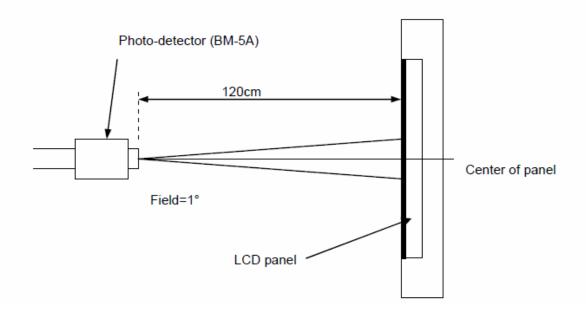
Part. No	KD024B-3C	REV	V1.0	Page 9 of 29
----------	-----------	-----	------	--------------



Note (3) Definition of Response Time : Sum of T_{R} and T_{F}



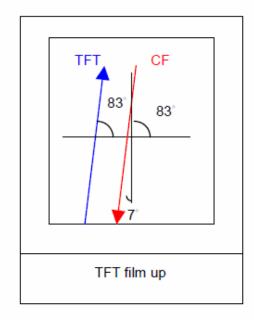
Note (4) Definition of optical measurement setup



Part. No	KD024B-3C	REV	V1.0	Page 10 of 29
----------	-----------	-----	------	---------------



Note (5) Rubbing Direction (The different Rubbing Direction will cause the different optima view direction.





5. Electrical Characteristics

5.1 Absolute Maximum Rating (Ta=25 VSS=0V)

Characteristics	Symbol	Min.	Max.	Unit
Digital Supply Voltage	VDD	-0.3	4.2	V
Digital interface supple Voltage	VDDIO	-0.3	VDD	V
Operating temperature	T _{OP}	-20	+70	$^{\circ}$ C
Storage temperature	T _{ST}	-30	+80	$^{\circ}$ C

5.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Тур.	Max.	Unit	Note
Digital Supply Voltage	VDD	2.6	33	4.2	V	
Digital interface supple Voltage	VDDIO	1.8	3.3	4.2	V	
Normal mode Current consumption	IDD		8		mA	
Level input voltage	V _{IH}	0.7VDDIO		VDDIO	V	
Level input voltage	VIL	GND		0.3VDDIO	V	
Lavel output valtage	V _{OH}	0.8VDDIO		VDDIO	V	
Level output voltage	V _{OL}	GND		0.2VDDIO	V	

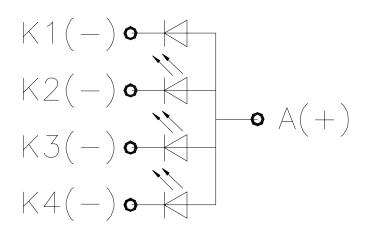
Part. No	KD024B-3C	REV	V1.0	Page 12 of 29
----------	-----------	-----	------	---------------



5.3 LED Backlight Characteristics

The back-light system is edge-lighting type with 4chips White LED

Item	Symbol	Min.	Тур.	Max.	Unit	Note
Forward Current	I_{F}	60	80		mA	
Forward Voltage	V_{F}		3.2		V	
LCM Luminance	L_{V}	350			cd/m2	IF=80MA
Uniformity	AVG	80			%	



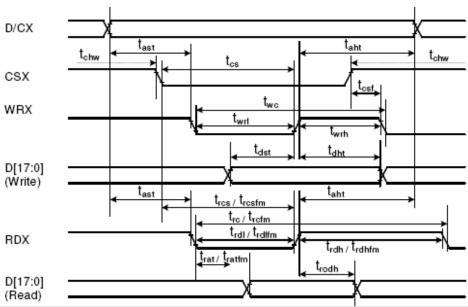
BLU CIRCUIT DIAGRAM

Part. No	KD024B-3C	REV	V1.0	Page 13 of 29
----------	-----------	-----	------	---------------



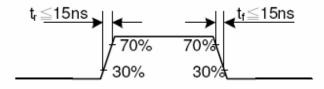
6. AC Characteristic

6.1 Display Parallel 8/16-bit Interface Timing Characteristics (8080- I system)



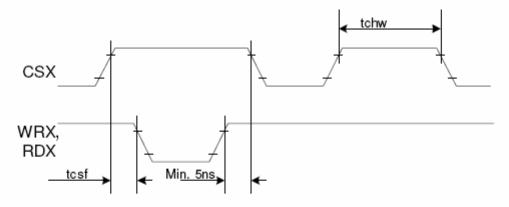
Signal	Symbol	Parameter	min	max	Unit	Description
DCV	tast	Address setup time	0	-	ns	
DGX		Address hold time (Write/Read)	0	-	ns	
	tchw	CSX "H" pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
CSX	trcs	Chip Select setup time (Read ID)	45	-	ns	
	tresfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
	twc	Write cycle	66	-	ns	
WRX	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
	trcfm	Read Cycle (FM)	450	-	ns	
RDX (FM)	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
	trc	Read cycle (ID)	160	-	ns	
RDX (ID)	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
D147-01	tdst	Write data setup time	10	-	ns	
D[17:0],	tdht	Write data hold time	10	-	ns	For maximum CL 2055
D[15:0],	trat	Read access time		40	ns	For maximum CL=30pF For minimum CL=8pF
D[8:0], D[7:0]	tratfm	Read access time	,	340	ns	For minimum CL=8pF
0[7.0]	trod	Read output disable time	20	80	ns	

Note: Ta = -30 to 70 ℃, VDDI=1.65V to 3.3V, VCI=2.5V to 3.3V, VSS=0V



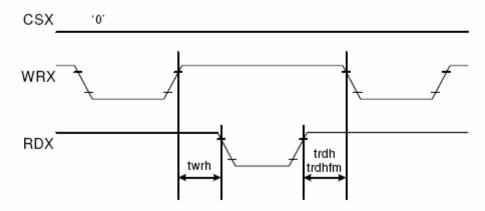
Part. No	KD024B-3C	REV	V1.0	Page 14 of 29
----------	-----------	-----	------	---------------

CSX timings:



Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Write to read or read to write timings:

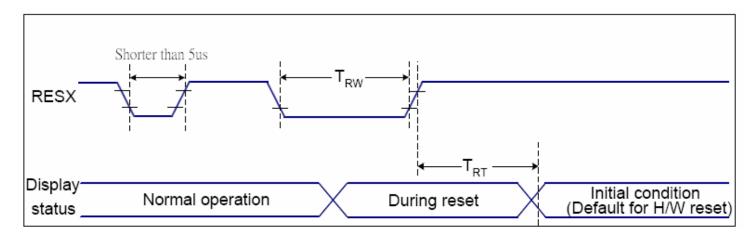


Note: Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Part. No	KD024B-3C	REV	V1.0	Page 15 of 29



6.2 Reset Timing Characteristics



VDDI=1.65 to 3.3V, VDD=2.4 to 3.3V, AGND=DGND=0V, Ta=-30 ~ 70 ℃

Related Pins	Symbol	Parameter	MIN	MAX	Unit
	TRW	Reset pulse duration	10	-	us
RESX TRT Reset cancel		-	5 (Note 1, 5)	ms	
		Reset cancer		120 (Note 1, 6, 7)	ms

Notes:

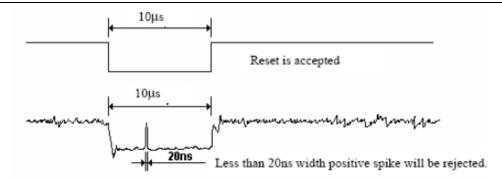
- The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5 ms after a rising edge of RESX.
 - 2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

- 3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.
 - 4. Spike Rejection also applies during a valid reset pulse as shown below:

Part. No	KD024B-3C	REV	V1.0	Page 16 of 29
----------	-----------	-----	------	---------------





- 5. When Reset applied during Sleep In Mode.
- 6. When Reset applied during Sleep Out Mode.
- It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for
 120msec.

Part. No	KD024B-3C	REV	V1.0	Page 17 of 29
1				

7. LCD Module Out-Going Quality Level

7.1 VISUAL & FUNCTION INSPECTION STANDARD

7.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

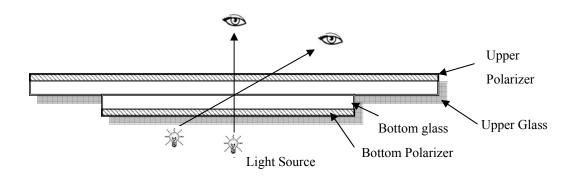
Temperature : 25±5 ℃

Humidity: 65%±10%RH

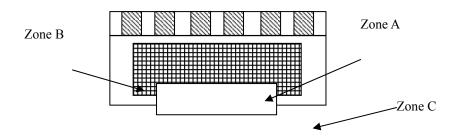
Viewing Angle: Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance:30-50cm



7.1.2 Definition



Zone A: Effective Viewing Area(Character or Digit can be seen)

Zone B: Viewing Area except Zone A

Zone C: Outside (Zone A+Zone B) which can not be seen after assembly by customer.)

Note:

As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer.

Part. No	KD024B-3C	REV	V1.0	Page 18 of 29
----------	-----------	-----	------	---------------



7.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class $\,\,$ AQL:

Major defect	Minor defect
0.65	1.5

LCD: Liquid Crystal Display , TP: Touch Panel , LCM: Liquid Crystal Module

No	Items to be	Criteria	Classification of
	inspected		defects
		1) No display, Open or miss line	
1	Eunational defeats	2) Display abnormally, Short	
1	1 Functional defects	3) Backlight no lighting, abnormal lighting.	Major
		4) TP no function	
2	Missing component		
3	Outline dimension	Overall outline dimension beyond the drawing is	
3	Outline difficultion	not allowed	
4	Color tone	Color unevenness, refer to limited sample	
5	Soldering appearance Good soldering, Peeling off is not allowed.		Minor
6	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

7.1.4 Criteria (Visual)

Number	Items	Criteria(mm)
1.0 LCD Crack/Broken		
NOTE: X: Length Y: Width Z: Height L: Length of ITO,	(1) The edge of LCD broken	$\begin{array}{ c c c c }\hline X & Y & Z \\ \hline \le 3.0 \text{mm} & < \text{Inner border line} \\ & \text{of the seal} & \le T \\ \hline \end{array}$

Part. No	KD024B-3C	REV	V1.0	Page 19 of 29
----------	-----------	-----	------	---------------



T: Height of LCD	(2)LCD corner broken					
		$\begin{array}{c cccc} X & Y & Z \\ \hline \leq 3.0 \text{mm} & \leq L & \leq T \end{array}$				
	(3) LCD crack	Crack Not allowed				

Part. No	KD024B-3C	REV	V1.0	Page 20 of 29

Number	Items			Criteria (mm)				
2.0	Spot defect	① light dot (LCD/TP/Polarizer black/white spot, light dot, pinhole, dent, stain)						
	<u> </u>	Zone	A	Acceptable Qty				
		Size (mm)	A	В	С			
		Ф≤0.10	Igno	re				
		0.10<Φ≤0.15	3(distance	≧ 10mm)	T			
		0.15<Φ≤0.2	1		Ignore			
	X	0.2<Ф	0					
	Ф=(X+Y)/2	②Dim spot (LCD/TI	1					
		Zone		Acceptable Qty				
		Size (mm)	A	В	С			
		Ф≤0.1						
		0.1<Φ≤0.2			Ignore			
		0.2<Ф≤0.3	1		ignore			
		$\Phi > 0.3$	0					
		3 Polarizer accidente	d spot					
		Zone		Acceptable Qty				
		Size (mm)	A	В	С			
		Ф≤0.2	Ign	ore				
		0.2<Ф≤0.5	2(distance	e ≥ 10mm)	Ignore			
		Ф>0.5		0				

Part. No	KD024B-3C	REV	V1.0	Page 21 of 29
----------	-----------	-----	------	---------------



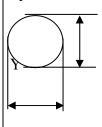
Line defect							
(LCD/TP /Polarizer black/white line, scratch,	W. 14 (A	Acceptable Qty			
	Width(mm)	Length(mm)	A B		С		
	Ф≤0.03	Ignore	Ignore				
stain)	0.03 <w≤0.05< td=""><td>L≤3.0</td><td colspan="2" rowspan="2">N≤2 N≤2</td><td>Ignore</td></w≤0.05<>	L≤3.0	N≤2 N≤2		Ignore		
	0.05 <w≤0.08< td=""><td>L≤2.0</td><td></td></w≤0.08<>	L≤2.0					
	0.08 <w< td=""><td>De</td><td>fine as spot</td><td>defect</td><td></td></w<>	De	fine as spot	defect			
Items	Criteria (mm)						

Part. No	KD024B-3C	REV	V1.0	Page 22 of 29



Spot defect

① light dot (LCD/TP/Polarizer black/white spot, light dot, pinhole, dent, stain)



<u> </u>	- , - 0	1 , 0	, 1	
Zone				
Size (mm)	A	С		
Ф≤0.10	Igr			
0.10<Φ≤0.15	3(distance	Jamana		
0.15<Φ≤0.2	1		Ignore	
0.2<Ф				

 $\Phi = (X+Y)/2$

X

②Dim spot (LCD/TP/Polarizer dim dot, light leakage、dark spot)

<u> </u>		<u> </u>	•	
Zone				
Size (mm)	A	В	С	
Ф≤0.1	Ign			
0.1<Φ≤0.2	2(distance	Ionoro		
0.2<Φ≤0.3		Ignore		
Ф > 0.3				

3 Polarizer accidented spot

Zone	A	7	
Size (mm)	A	В	С
Ф≤0.2	Igno		
0.2<Φ≤0.5	2(distance	Ignore	
Ф>0.5	0		

Line defect (LCD/TP /Polarizer black/white line, scratch, stain)

Width(mm)	Langth(mm)	Acceptable Qty				
Width(mm)	Length(mm)	A	В	С		
Ф≤0.03	Ignore	Ignore				
0.03 <w≤0.05< td=""><td>L≤3.0</td><td>N≤</td><td>Ignore</td></w≤0.05<>	L≤3.0	N≤	Ignore			
0.05 <w≤0.08< td=""><td>L≤2.0</td><td colspan="2">N≤2</td><td></td></w≤0.08<>	L≤2.0	N≤2				
0.08 <w< td=""><td colspan="5">Define as spot defect</td></w<>	Define as spot defect					

Part. No	KD024B-3C	REV	V1.0	Page 23 of 29



D-1											
Polarizer Bubble					11 0						
Buoole		Zone		Accepta	ble Qty						
	Size (mm)		A	В		C					
	Ф≤0.	2		Ignore							
	0.2<Φ≤	0.4	2(dista	nce≧10mm	1)	Ignore					
	0.4<Φ≤	0.6		1		ignore					
	0.6<0	Þ		0							
SMT	According defect, the o				ndard .	Function	n defect	and mis	ssing	part	are
	TP bubble/ accidented spot	0.1· 0.2·	Φ(mm) Θ≤0.1 <Φ≤0.2 <Φ≤0.3 3<Φ	A Ig 2 (distant	Acceptal Begin or e $ce \ge 10m$ $ce \ge 10m$	3	C Ignore				
	Assembly deflection	0.3<Φ 0 beyond the edge of backlight ≤0.15mm									

Part. No	KD024B-3C	REV	V1.0	Page 24 of 29



5.0	TP Related	Newton Ring	Newton Ring area≥1/3 TP area NG Newton Ring area≤1/3 TP area OK 2.排兒書生
		TP corner broken X: length Y: width Z: height	$\begin{array}{ c c c c c c }\hline X & Y & Z \\\hline X \leqslant 3.0 \text{mm} & Y \leqslant 3.0 \text{mm} & Z < LCD \\ * & \\\hline \text{Circuitry broken is not allowed.} & \\\hline \end{array}$
		TP edge broken X: length Y: width Z: height	$\begin{array}{ c c c c c c }\hline X & Y & Z \\ \hline X \leqslant 6.0 \text{mm} & Y \leqslant 2.0 \text{mm} & Z < LCD \\ \hline \text{thickness} \\ \hline * Circuitry broken is not allowed. \\ \hline \end{array}$

Part. No	KD024B-3C	REV	V1.0	Page 25 of 29
----------	-----------	-----	------	---------------



Criteria (functional items)

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed
5	TP no function	Not allowed

Part. No KD024B-3C REV V1.0 Page 26 of 29	Part. No	KD024B-3C	REV	V1.0	Page 26 of 29
---	----------	-----------	-----	------	---------------



8. Reliability Test Result

8.1 Condition

Item	Condition	Sample Size	Test Result	Note
Low Temperature Operating Life test	-20℃, 96HR	3ea	pass	-
Thermal Humidity Operating Life test	60℃, 90%RH, 96HR	3ea	pass	-
Temperature Cycle ON/OFF test	-20°C ↔ 70°C, ON/OFF, 20CYC	3ea	pass	(1)
High Temperature Storage test	80℃, 96HR	3ea	pass	-
Low Temperature Storage test	−30°C,96HR	3ea	pass	-
Thermal Shock Resistance	The sample should be allowed to stand the following 5 cycles of operation: TSTL for 30 minutes -> normal temperature for 5 minutes -> TSTH for 30 minutes -> normal temperature for 5 minutes, as one cycle, then taking it out and drying it at normal temperature, and allowing it stand for 24 hours	3ea	pass	
Box Drop Test	1 Corner 3 Edges 6 faces, 66cm(MEDIUM BOX)	1box	pass	-

Note (1) ON Time over 10 seconds, OFF Time under 10 seconds

Part. No	KD024B-3C	REV	V1.0	Page 27 of 29
----------	-----------	-----	------	---------------



9. Cautions and Handling Precautions

9.1 Handling and Operating the Module

- (1) When the module is assembled, it should be attached to the system firmly.
- Do not warp or twist the module during assembly work.
- (2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- (3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- (4) Do not allow drops of water or chemicals to remain on the display surface.
- If you have the droplets for a long time, staining and discoloration may occur.
- (5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- (6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.
- Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- (7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- (8) Protect the module from static; it may cause damage to the CMOS ICs.
- (9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- (10) Do not disassemble the module.
- (11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- (12) Pins of I/F connector shall not be touched directly with bare hands.
- (13) Do not connect, disconnect the module in the "Power ON" condition.
- (14) Power supply should always be turned on/off by the item 6.1 Power On Sequence &6.2 Power Off Sequence

9.2 Storage and Transportation.

- (1) Do not leave the panel in high temperature, and high humidity for a long time.
- It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- (2) Do not store the TFT-LCD module in direct sunlight.
- (3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- (4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.
- In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- (5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

Part. No	KD024B-3C	REV	V1.0	Page 28 of 29
----------	-----------	-----	------	---------------



10.Packing

---TBD----

Part.	No	KD024B-3C	REV	V1.0	Page 29 of 29
					3